

Combined Environments Testing

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Topics

- What is Combined Environments Testing (CET)?
- CET Chamber
- CET Profile
- CET Steps

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What is Combined Environments Testing?

- Based on modified Highly Accelerated Life Test (HALT)
 - Goal: Quickly break products and learn from the failure modes
 - Identify design and process problems
 - Shorter time frame
 - Smaller number of test samples
 - Stressed beyond specification and typical use environments

Thermal extremes

Extreme thermal rates of change

Vibration

Combination of thermal and vibration

- Perceived Problems
 - Not a true life test (no modeling)
- Compare lead-free solder alloy performance against the standard tin lead eutectic solder



Combined Environments Chamber

- QualMark HALT/HASS chamber located in McKinney, Texas
- Thermal
 - Liquid nitrogen for cooling
 - Nichrome heater elements for heating
 - Thermal capability ranges from -100 to 200 °C
 - Ramp rates of up to 60 °C per minute
- Vibration
 - Generated by pneumatically driven vibrators attached to the bottom of the table
 - Maximum levels of > 60 Grms
 - 6 DOF application (linear and rotational)
- Thermal and vibration environments can be applied separately or combined



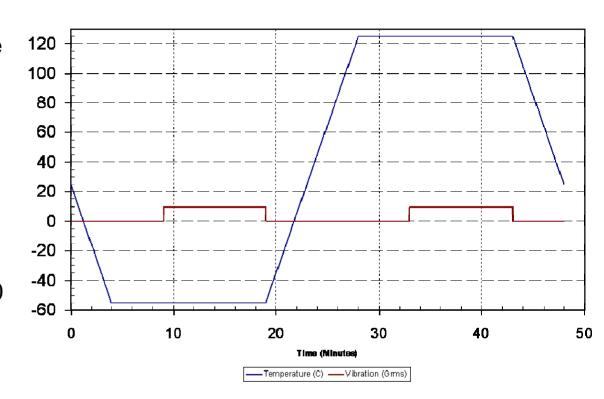


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Combined Environments Test Parameters

Thermal

- -55 to 125 °C temperature cycle
- 20 °C per minute ramp
- 15 minute soak
- Vibration
 - During last 10 minutes of soak period
 - 10 Grms initial
 - Increase 5 Grms after 100 cycles
 - 20 Grms to significant failures
- Test Vehicles
 - 15 Manufacturing
 - 15 Repair





Combined Environments Testing Steps

- Test Setup
 - Fabricate fixture
 - Solder cables to test vehicles
 - Pretest inspection
- Execute Test
 - Test 3 lots of 10 test vehicles at a time
 - Utilize Anatech event detectors
 - Post test inspection
- Failure Analysis
 - Microsection analysis
- Data Analysis
- Publish Test Report